

Docket No.: 085027-0108

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 89518
:
Mou-Shiung Lin, et al. : Confirmation Number: 1870
:
Application No.: 10/796,427 : Group Art Unit: 2894
:
Patent No.: 7,470,997 : Issued: December 30, 2008
:
For: WIREBOND PAD FOR SEMICONDUCTOR CHIP OR WAFER

TRANSMITTAL OF POWER OF ATTORNEY

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF ELECTRONIC TRANSMISSION


I hereby certify that this correspondence is being electronically-transmitted to the
United States Patent and Trademark Office on March 28, 2011.
/Patricia A. Balero:
Patricia A. Balero

Sir:

Transmitted herewith is a Fee Address Indication Form, Power Of Attorney to Prosecute
Applications Before the USPTO, together with a Statement Under 37 CFR 3.73(b), which
revokes all previous powers of attorney given in the above-identified application and associates
the application with Customer Number 89518.

Respectfully submitted,

McDERMOTT WILL & EMERY LLP



Dennis A. Duchene
Registration No. 40,595

11682 El Camino Real, Suite 400
San Diego, CA 92130
Phone: 858.720.3300
Facsimile: 858.720.7800
Date: March 28, 2011

**Please recognize our Customer No. 89518
as our correspondence address.**